

## PATENT ASSIGNMENT COVER SHEET

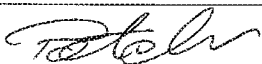
Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT3953792

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
MACIEJ PATELKA	07/04/2016
CATHY SHAW TRUMBLE	07/04/2016
NORIYUKI SAKAI	07/04/2016
HIROSHI YAMAGUCHI	07/04/2016
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	NAMICS CORPORATION
<b>Street Address:</b>	3993, NIGORIKAWA, KITA-KU
<b>City:</b>	NIIGATA-SHI, NIIGATA
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	950-3131
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	15110575
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	(212)319-4900
<b>Email:</b>	akulkarni@hhpatent.com
<b>Correspondent Name:</b>	HOLTZ, HOLTZ, & VOLEK PC
<b>Address Line 1:</b>	630 NINTH AVENUE
<b>Address Line 2:</b>	SUITE 1010
<b>Address Line 4:</b>	NEW YORK, NEW YORK 10036-3744
<b>ATTORNEY DOCKET NUMBER:</b>	14010PCT/RSB
<b>NAME OF SUBMITTER:</b>	AMIT KULKARNI
<b>SIGNATURE:</b>	/ak/
<b>DATE SIGNED:</b>	07/08/2016
This document serves as an Oath/Declaration (37 CFR 1.63).	
<b>Total Attachments: 4</b>	

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source=14010PCTRSB\_Declaration\_Assignment#page4.tif

## Combined Declaration and Assignment for Utility or Design Application

Title of Invention	CONDUCTIVE PASTE AND METHOD FOR PRODUCING A SEMICONDUCTOR DEVICE USING THE SAME	
As the below named inventor, I hereby declare that:		
This declaration is directed to:	<input type="checkbox"/> The attached application, or <input checked="" type="checkbox"/> United States application or PCT international application number <u>PCT/JP2015/051743</u> filed on <u>January 15, 2015</u> .	
The above-identified application was made or authorized to be made by me.		
I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.		
In consideration of value received, I sell and assign to <u>NAMICS CORPORATION</u> , having a business address at <u>3993, Nigorikawa, Kita-ku, Niigata-shi, Niigata 950-3131 Japan</u> , its successors, assigns or nominees, hereinafter referred to as "Assignee", my entire right, title and interest in and to said invention, and in and to all applications for patent and patents for said invention, in all countries of the world, including all divisions, reissues, continuations, substitutions and extensions thereof and all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of intellectual property, including rights of priority, resulting from the filing of any of said applications.		
I authorize said Assignee to file and prosecute an application or applications for patent for said invention as the applicant, and I request any official whose duty it is to issue patents, to issue any patent on said invention to said Assignee.		
I agree that on request and without further consideration, but at the expense of said Assignee, I will communicate to said Assignee or its representatives all facts known to me respecting said invention and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue, or other applications, make all rightful oaths and declarations, and generally do everything possible to aid said Assignee to obtain and enforce proper patent protection for said invention in all countries.		
I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.		
LEGAL NAME OF INVENTOR		
Maciej PATELKA		July 4, 2016
Inventor (printed name)	Signature	Date

**Holtz, Holtz, Goodman & Chick PC**  
220 Fifth Avenue, 16th Floor, New York, NY 10001-7708  
Tel. (212) 319-4900 Fax. (212) 319-5101

**Combined Declaration and Assignment for Utility or Design Application****Title of  
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address at 3993, Nigorikawa, Kita-ku, Niigata-shi, Niigata 950-3131 Japan, its successors, assigns or  
nominees, hereinafter referred to as "Assignee", my entire right, title and interest in and to said invention,  
and in and to all applications for patent and patents for said invention, in all countries of the world,  
including all divisions, reissues, continuations, substitutions and extensions thereof and all rights arising  
under or pursuant to any and all international agreements, treaties or laws relating to the protection of  
intellectual property, including rights of priority, resulting from the filing of any of said applications.

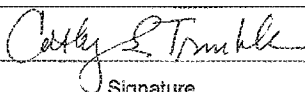
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## LEGAL NAME OF INVENTOR

Cathy Shaw TRUMBLE



July 4, 2016

Inventor (printed name)

Signature

Date

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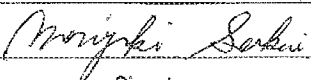
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## LEGAL NAME OF INVENTOR

Noriyuki SAKAI		July 4, 2016
Inventor (printed name)	Signature	Date

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LEGAL NAME OF INVENTOR		
Hiroshi YAMAGUCHI	<i>Hiroshi Yamaguchi</i>	July 4, 2016
Inventor (printed name)	Signature	Date

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